

CRMNTU3400A

N-Channel 30V, 16.6mΩ Typ. Power MOSFET

Description

Features

• 30V, 6.5A

 $R_{DS(ON)}$ Typ = 16.6m Ω @ V_{GS} = 10V

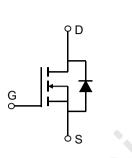
 $R_{DS(ON)}$ Typ = 18m Ω @ V_{GS} = 4.5V

 $R_{DS(ON)}$ Typ = 24m Ω @ V_{GS} = 2.5V

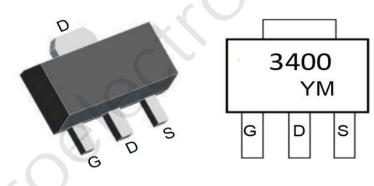
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- Lead Free

Application

- Load Switch
- PWM Application
- Power Management



Schematic Diagram



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMNTU3400A	3400	SOT-89-3L	TAPING	7"	1000	32000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		30	V
V _{GS}	Gate-to-Source Voltage		±12	V
	Continuous Drain Current	T _A = 25°C	6.5	А
l _D	Continuous Drain Current	T _A = 100°C	3.9	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		26	A
P _D	Power Dissipation	T _A = 25°C	1.6	W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambie	ent ⁽²⁾	80	°C/W
T _J , T _{STG}	Junction & Storage Temperature Rang	e	-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 30V, V _{GS} = 0V	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 12V$	-	-	±100	nA
On Chara	acteristics				6	
V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	0.5	0.9	1.3	V
R _{ds(on)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 10V, I _D = 3.5A	-	16.6	21.6	mΩ
		V _{GS} = 4.5V, I _D = 3A	-	18	23.4	mΩ
		V _{GS} = 2.5V, I _D = 2.5A	-	24	31.2	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		X-/	816	-	pF
C _{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz		60	-	pF
C _{rss}	Reverse Transfer Capacitance		9.	50	-	pF
Qg	Total Gate Charge		-	19	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 15V$, $I_{D} = 3A$	-	2	-	nC
Q_gd	Gate Drain("Miller") Charge	$v_{\rm DS} = 10$ v, $v_{\rm D} = 0$ A	-	2.1	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime	-	-	4	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 15V	-	11	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 3A, R_{GEN} = 3 Ω	-	24	-	ns
t _f	Turn-Off Fall Time		-	2	-	ns
Drain-So	urce Diode Characteristics and N	lax Ratings				
I _S	Maximum Continuous Drain to Source Diode Forward Current			-	6.5	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	26	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 3.5A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	I _F = 3A, di/dt = 100A/us	-	8.4	-	ns
Qrr	Body Diode Reverse Recovery Charge		-	3.3	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. $R_{\mbox{\tiny 8JA}}$ is measured with the device mounted on a 1inch^2 pad of 2oz copper FR4 PCB

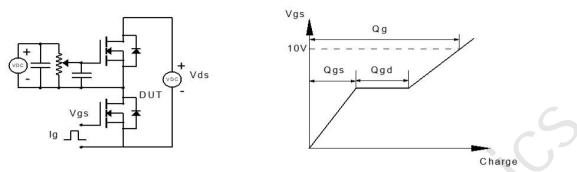
3. Pulse Test: Pulse Width ${\leqslant}300\mu s,$ Duty Cycle ${\leqslant}0.5\%.$

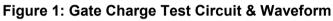


CRMNTU3400A

N-Channel 30V, 16.6mΩ Typ. Power MOSFET

Test Circuit





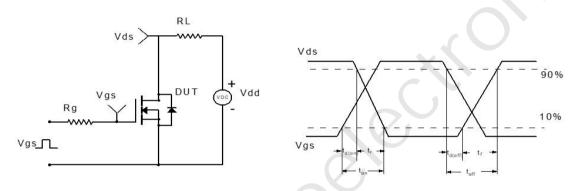


Figure 2: Resistive Switching Test Circuit & Waveform

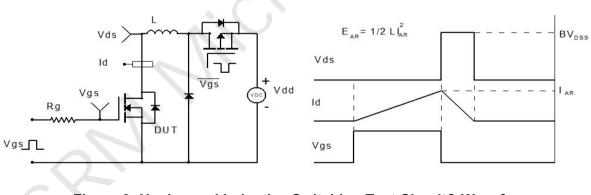


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

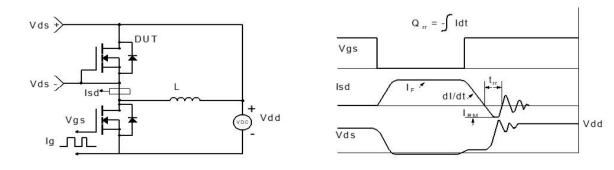


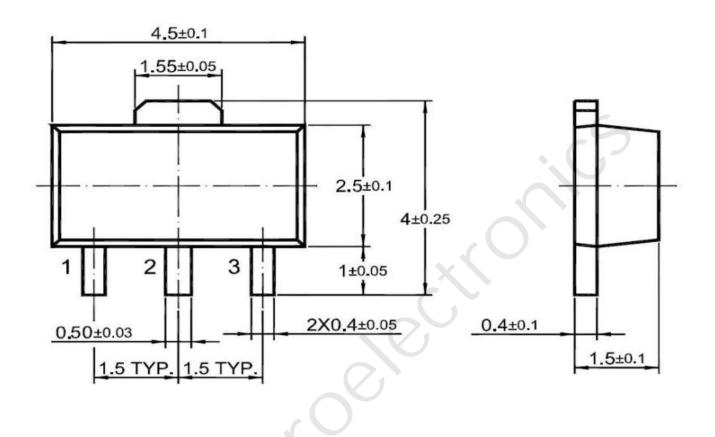
Figure 4: Diode Recovery Test Circuit & Waveform



CRMNTU3400A

N-Channel 30V, 16.6mΩ Typ. Power MOSFET

Package Mechanical Data(SOP-89-3L)



Important Notice

The information presented in datasheets is for reference only. CRM reserves the right to make changes at any time to any products or information herein, without notice. Customers are responsible for the design and applications, including compliance

with all laws, regulations and safety requirements or standards.

"Typical" parameters which provided in datasheets can vary in different applications and actual performance may vary over time. Customers are responsible for doing all necessary testing to minimize the risks associated with their applications and products.

is a registered trademark of Wuxi CRM Microelectronics Co. , Ltd. Copyright ©2023 CRM Microelectronics Co. , Ltd. All rights reserved.

Contact information

For more information, please visit: http://www.crm-semi.tech For sales information, please send an email to: sales@crm-semi.com